# 74LVC1G3157

# 2-channel analog multiplexer/demultiplexer

Rev. 02 — 18 September 2007

**Product data sheet** 

## 1. General description

The 74LVC1G3157 is a low-power, low-voltage, high-speed Si-gate CMOS device.

The 74LVC1G3157 provides one analog multiplexer/demultiplexer with one digital select input (S), two independent inputs/outputs (Y0, Y1) and a common input/output (Z).

Schmitt trigger action at the select input makes the circuit tolerant of slower input rise and fall times across the entire  $V_{CC}$  range from 1.65 V to 5.5 V.

#### 2. Features

- Wide supply voltage range from 1.65 V to 5.5 V
- Very low ON resistance:
  - 7.5  $\Omega$  (typical) at  $V_{CC} = 2.7 \text{ V}$
  - 6.5  $\Omega$  (typical) at  $V_{CC} = 3.3 \text{ V}$
  - 6  $\Omega$  (typical) at  $V_{CC} = 5 \text{ V}$
- Switch current capability of 32 mA
- Break-before-make switching
- High noise immunity
- CMOS low power consumption
- TTL interface compatibility at 3.3 V
- Latch-up performance meets requirements of JESD 78 Class I
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Control input accepts voltages up to 5.5 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



# 3. Ordering information

Table 1. Ordering information

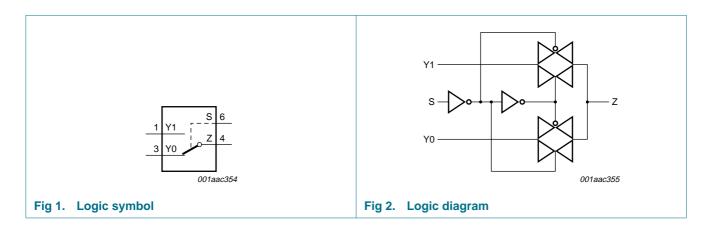
Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC1G3157GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363						
74LVC1G3157GV	–40 °C to +125 °C	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457						
74LVC1G3157GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886						
74LVC1G3157GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1 $\times$ 0.5 mm	SOT891						

# 4. Marking

Table 2. Marking

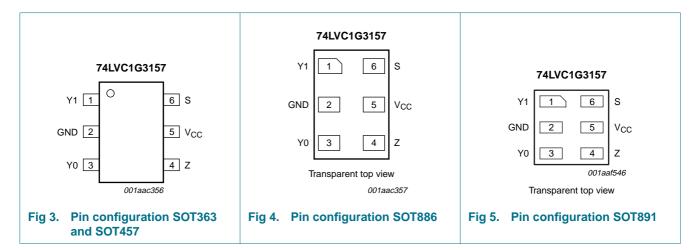
Type number	Marking code
74LVC1G3157GW	YJ
74LVC1G3157GV	YJ
74LVC1G3157GM	YJ
74LVC1G3157GF	YJ

# 5. Functional diagram



# 6. Pinning information

### 6.1 Pinning



## 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
Y1	1	independent input or output
GND	2	ground (0 V)
Y0	3	independent input or output
Z	4	common output or input
V <sub>CC</sub>	5	supply voltage
S	6	select input

# 7. Functional description

Table 4. Function table[1]

Input S	Channel on
L	Y0
Н	Y1

[1] H = HIGH voltage level;L = LOW voltage level.

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
$I_{IK}$	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±50	mA
$V_{SW}$	switch voltage	enable and disable mode	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
$I_{SW}$	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	<u>[3]</u> _	250	mW

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	5.5	V
VI	input voltage		0	-	5.5	V
V <sub>SW</sub>	switch voltage	enable and disable mode	<u>[1]</u> 0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC}$ = 1.65 V to 2.7 V	[2] _	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$	[2] _	-	10	ns/V

<sup>[1]</sup> To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

<sup>[2]</sup> The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

<sup>[3]</sup> For SC-88 and SC-74 packages: above 87.5 °C the value of P<sub>tot</sub> derates linearly with 4.0 mW/K. For XSON6 packages: above 45 °C the value of P<sub>tot</sub> derates linearly with 2.4 mW/K.

<sup>[2]</sup> Applies to control signal levels.

## 10. Static characteristics

Table 7. Static characteristics

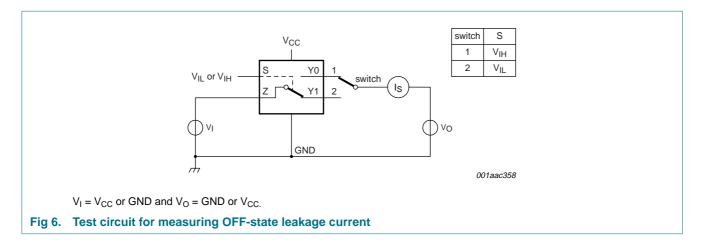
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

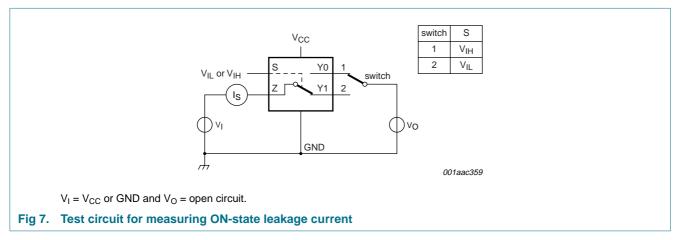
	Parameter	Conditions		- <b>40</b> °	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.65 V to 1.95 V		0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V		1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 3 V to 3.6 V		2.0	-	-	2.0	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V		$0.7V_{CC}$	-	-	$0.7V_{CC}$	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 1.65 V to 1.95 V		-	-	$0.35V_{CC}$	-	$0.35V_{CC}$	V
	input voltage	V <sub>CC</sub> = 2.3 V to 2.7 V		-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 3 V to 3.6 V		-	-	0.8	-	8.0	V
		V <sub>CC</sub> = 4.5 V to 5.5 V		-	-	$0.3V_{CC}$		$0.3V_{CC}$	V
I <sub>I</sub>	input leakage current	pin S; $V_1 = 5.5 \text{ V or GND}$ ; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	[2]	-	±0.1	±2	-	±10	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5 V$ ; see Figure 6	[2]	-	±0.1	±5	-	±20	μА
I <sub>S(ON)</sub>	ON-state leakage current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5 V$ ; see Figure 7	[2]	-	±0.1	±5	-	±20	μА
I <sub>CC</sub>	supply current	$V_{I} = 5.5 \text{ V or GND};$ $V_{SW} = \text{GND or } V_{CC}; I_{O} = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$	[2]	-	0.1	10	-	40	μА
$\Delta I_{CC}$	additional supply current	$\begin{aligned} &\text{pin S; V}_{\text{I}} = \text{V}_{\text{CC}} - 0.6 \text{ V; I}_{\text{O}} = 0 \text{ A;} \\ &\text{V}_{\text{CC}} = 5.5 \text{ V; V}_{\text{SW}} = \text{GND or V}_{\text{CC}} \end{aligned}$	[2]	-	5	500	-	5000	μΑ
Cı	input capacitance			-	2.5	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance			-	6.0	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance			-	18	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

<sup>[2]</sup> These typical values are measured at  $V_{CC}$  = 3.3 V

#### 10.1 Test circuits





#### 10.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 9 to Figure 14.

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to	+125 °C	Unit	
			Min	Typ[1]	Max	Min	Max	
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = GND$ to $V_{CC}$ ; see <u>Figure 8</u>						
		$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	34.0	130	-	195	Ω
		$I_{SW}$ = 8 mA; $V_{CC}$ = 2.3 V to 2.7 V	-	12.0	30	-	45	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	10.4	25	-	38	Ω
		$I_{SW}$ = 24 mA; $V_{CC}$ = 3 V to 3.6 V	-	7.8	20	-	30	Ω
		$I_{SW}$ = 32 mA; $V_{CC}$ = 4.5 V to 5.5 V	-	6.2	15	-	23	Ω

 Table 8.
 ON resistance ...continued

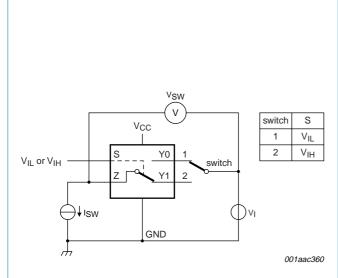
At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 9 to Figure 14.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
R <sub>ON(rail)</sub>	ON resistance (rail)	V <sub>I</sub> = GND; see <u>Figure 8</u>						
		$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	8.2	18	-	27	Ω
		$I_{SW}$ = 8 mA; $V_{CC}$ = 2.3 V to 2.7 V	-	7.1	16	-	24	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	6.9	14	-	21	Ω
		$I_{SW}$ = 24 mA; $V_{CC}$ = 3 V to 3.6 V	-	6.5	12	-	18	Ω
		$I_{SW}$ = 32 mA; $V_{CC}$ = 4.5 V to 5.5 V	-	5.8	10	-	15	Ω
		V <sub>I</sub> = V <sub>CC</sub> ; see <u>Figure 8</u>						
		$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	10.4	30	-	45	Ω
		$I_{SW}$ = 8 mA; $V_{CC}$ = 2.3 V to 2.7 V	-	7.6	20	-	30	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	7.0	18	-	27	Ω
		$I_{SW}$ = 24 mA; $V_{CC}$ = 3 V to 3.6 V	-	6.1	15	-	23	Ω
		$I_{SW}$ = 32 mA; $V_{CC}$ = 4.5 V to 5.5 V	-	4.9	10	-	15	Ω
$R_{ON(flat)} \\$	ON resistance	$V_I = GND \text{ to } V_{CC}$						
	(flatness)	$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	26.0	-	-	-	Ω
		$I_{SW}$ = 8 mA; $V_{CC}$ = 2.3 V to 2.7 V	-	5.0	-	-	-	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	3.5	-	-	-	Ω
		$I_{SW}$ = 24 mA; $V_{CC}$ = 3 V to 3.6 V	-	2.0	-	-	-	Ω
		$I_{SW}$ = 32 mA; $V_{CC}$ = 4.5 V to 5.5 V	-	1.5	-	-	-	Ω

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and nominal  $V_{CC}$ .

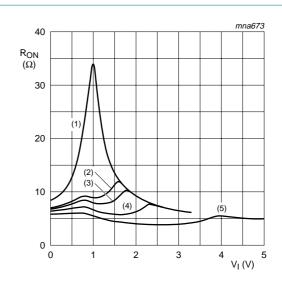
<sup>[2]</sup> Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

## 10.3 ON resistance test circuit and graphs



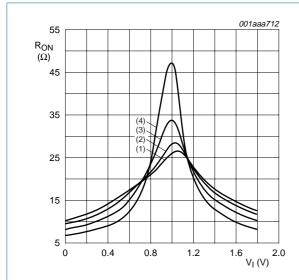
 $R_{ON} = V_{SW} / I_{SW}$ 

Fig 8. Test circuit for measuring ON resistance



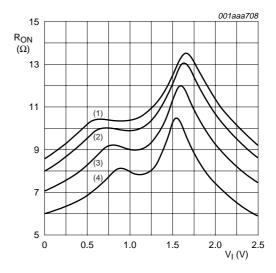
- (1)  $V_{CC} = 1.8 \text{ V}.$
- (2)  $V_{CC} = 2.5 \text{ V}.$
- (3)  $V_{CC} = 2.7 \text{ V}.$
- (4)  $V_{CC} = 3.3 \text{ V}.$
- (5)  $V_{CC} = 5.0 \text{ V}.$

Fig 9. Typical ON resistance as a function of input voltage;  $T_{amb} = 25 \, ^{\circ}C$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

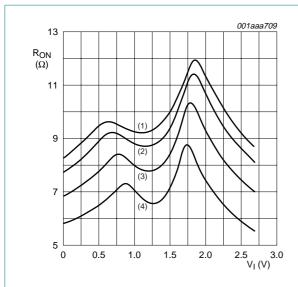
Fig 10. ON resistance as a function of input voltage;  $V_{CC} = 1.8 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

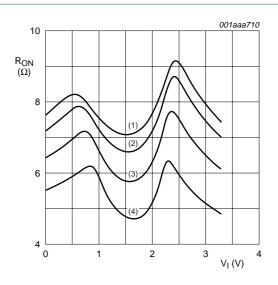
Fig 11. ON resistance as a function of input voltage;  $V_{CC} = 2.5 \text{ V}$ 

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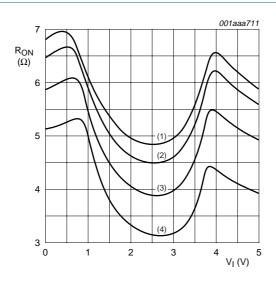
- (1)  $T_{amb} = 125 \, {}^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 12. ON resistance as a function of input voltage;  $V_{CC} = 2.7 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 13. ON resistance as a function of input voltage;  $V_{CC} = 3.3 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 14. ON resistance as a function of input voltage; V<sub>CC</sub> = 5.0 V

## 11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	Z to Yn or Yn to Z; see Figure 15	[2][3]				'		
		$V_{CC}$ = 1.65 V to 1.95 V		-	-	2	-	3.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	1.2	-	2.0	ns
		$V_{CC} = 2.7 \text{ V}$		-	-	1.0	-	1.5	ns
		$V_{CC}$ = 3 V to 3.6 V		-	-	0.8	-	1.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-	-	0.6	-	1.0	ns
t <sub>en</sub>	enable time	S to Yn; see Figure 16	<u>[4]</u>						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	8.7	14	1.0	14.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	5.3	7.5	1.0	7.5	ns
	$V_{CC} = 2.7 \text{ V}$		1.0	4.9	6.0	1.0	6.0	ns	
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		0.5	4.0	5.5	0.5	5.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	3.0	4.0	0.5	4.0	ns
t <sub>dis</sub>	disable time	S to Yn; see Figure 16	<u>[5]</u>						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.5	6.0	8.5	2.5	8.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.0	4.4	6.0	2.0	6.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.5	4.2	5.0	1.5	5.0	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		1.5	3.6	4.5	1.5	4.5	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		8.0	2.9	3.5	8.0	3.5	ns
t <sub>b-m</sub>	break-before-make	see Figure 17	<u>[6]</u>						
	time	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		0.5	-	-	0.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		0.5	-	-	0.5	-	ns
		$V_{CC} = 2.7 V$		0.5	-	-	0.5	-	ns
		$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		0.5	-	-	0.5	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.5	-	-	0.5	-	ns

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and nominal  $V_{CC}$ .

<sup>[2]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

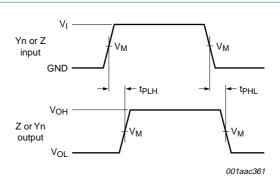
<sup>[3]</sup> Propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified capacitance when driven by an ideal voltage source (zero output impedance).

<sup>[4]</sup>  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

<sup>[5]</sup> t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.

<sup>[6]</sup> Break-before-make specified by design.

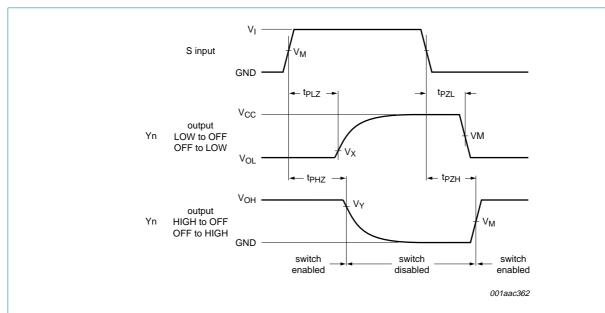
#### 11.1 Waveforms and test circuits



Measurement points are given in Table 10.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 15. Input (Yn or Z) to output (Z or Yn) propagation delays



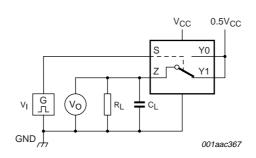
Measurement points are given in Table 10.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

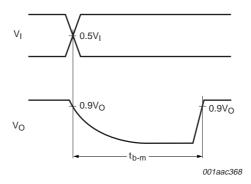
Fig 16. Enable and disable times

Table 10. Measurement points

Supply voltage	Input	Output				
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>		
1.65 V to 5.5 V	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V		

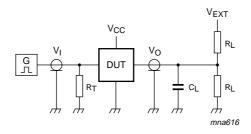


#### a. Test circuit



b. Input and output measurement points

Fig 17. Test circuit for measuring break-before-make timing



Test data is given in Table 11.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 18. Load circuit for switching times

Table 11. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
V <sub>CC</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
1.65 V to 1.95 V	$V_{CC}$	$\leq$ 2.0 ns	50 pF	$500 \Omega$	open	GND	2V <sub>CC</sub>
2.3 V to 2.7 V	$V_{CC}$	≤ 2.0 ns	50 pF	$500~\Omega$	open	GND	2V <sub>CC</sub>
2.7 V	$V_{CC}$	≤ 2.5 ns	50 pF	$500~\Omega$	open	GND	2V <sub>CC</sub>
3 V to 3.6 V	$V_{CC}$	≤ 2.5 ns	50 pF	$500~\Omega$	open	GND	$2V_{CC}$
4.5 V to 5.5 V	$V_{CC}$	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	2V <sub>CC</sub>

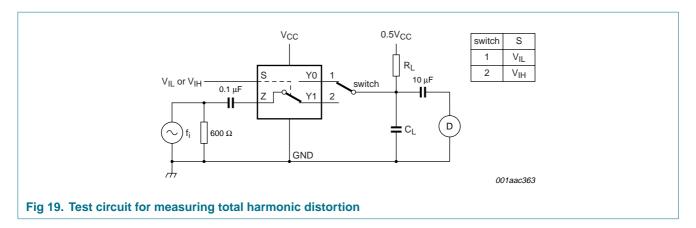
## 11.2 Additional dynamic characteristics

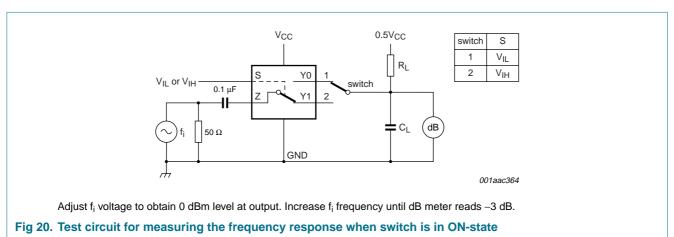
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T<sub>amb</sub> = 25 °C.

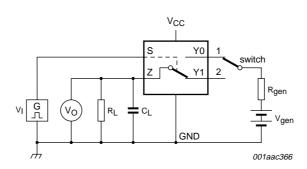
		<u>-</u>	, unio			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$\begin{aligned} &f_i = 600 \text{ Hz to } 20 \text{ kHz; } R_L = 600 \ \Omega; \\ &C_L = 50 \text{ pF; } V_I = 0.5 \text{ V (p-p);} \\ &\text{see } \frac{\text{Figure } 19}{\text{ or } 19} \end{aligned}$				
		V <sub>CC</sub> = 1.65 V	-	0.260	-	%
		V <sub>CC</sub> = 2.3 V	-	0.078	-	%
		$V_{CC} = 3.0 \text{ V}$	-	0.078	-	%
		V <sub>CC</sub> = 4.5 V	-	0.078	-	%
f <sub>(-3dB)</sub>	-3 dB frequency response	$R_L = 50 \Omega$ ; $C_L = 5 pF$ ; see Figure 20				
		V <sub>CC</sub> = 1.65 V	-	200	-	MHz
		V <sub>CC</sub> = 2.3 V	-	300	-	MHz
		V <sub>CC</sub> = 3.0 V	-	300	-	MHz
		V <sub>CC</sub> = 4.5 V	-	300	-	MHz
$lpha_{iso}$	isolation (OFF-state)	$R_L = 50 \Omega$ ; $C_L = 5 pF$ ; $f_i = 10 MHz$ ; see Figure 21				
		V <sub>CC</sub> = 1.65 V	-	-42	-	dB
		V <sub>CC</sub> = 2.3 V	-	-42	-	dB
		V <sub>CC</sub> = 3.0 V	-	-40	-	dB
		V <sub>CC</sub> = 4.5 V	-	-40	-	dB
Q <sub>inj</sub>	charge injection	$C_L$ = 0.1 nF; $V_{gen}$ = 0 V; $R_{gen}$ = 0 $\Omega$ ; $f_i$ = 1 MHz; $R_L$ = 1 M $\Omega$ ; see Figure 22				
		V <sub>CC</sub> = 1.8 V	-	3.3	-	pC
		V <sub>CC</sub> = 2.5 V	-	4.1	-	pC
		V <sub>CC</sub> = 3.3 V	-	5.0	-	рС
		V <sub>CC</sub> = 4.5 V	-	6.4	-	рС
		V <sub>CC</sub> = 5.5 V	-	7.5	-	рС

#### 11.3 Test circuits

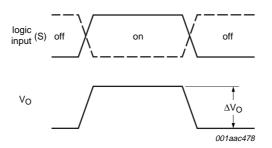




0.5V<sub>CC</sub> V<sub>CC</sub> 0.5V<sub>CC</sub> Switch S 1 V<sub>IL</sub> V<sub>IL</sub> V<sub>IL</sub> V<sub>IL</sub> V<sub>IL</sub> S V<sub>IL</sub> Switch S 1 V<sub>IL</sub> V<sub>IL</sub> V<sub>IL</sub> S V<sub>IL</sub> Switch S 1 V<sub>IL</sub> V<sub>IL</sub> S V<sub>IL</sub> Switch S 1 V<sub>IL</sub> S V<sub>IL</sub>



a. Test circuit



b. Input and output pulse definitions

 $Q_{inj} = \Delta V_O \times C_L.$ 

 $\Delta V_{O}$  = output voltage variation.

R<sub>gen</sub> = generator resistance.

V<sub>gen</sub> = generator voltage.

Fig 22. Test circuit for measuring charge injection

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# 12. Package outline

#### Plastic surface-mounted package; 6 leads

**SOT363** 

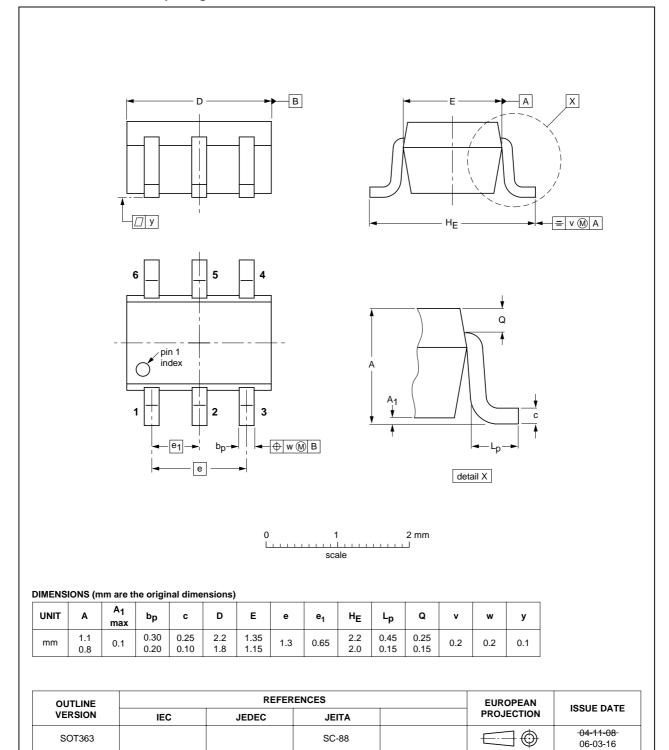


Fig 23. Package outline SOT363 (SC-88)

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### Plastic surface-mounted package (TSOP6); 6 leads

**SOT457** 

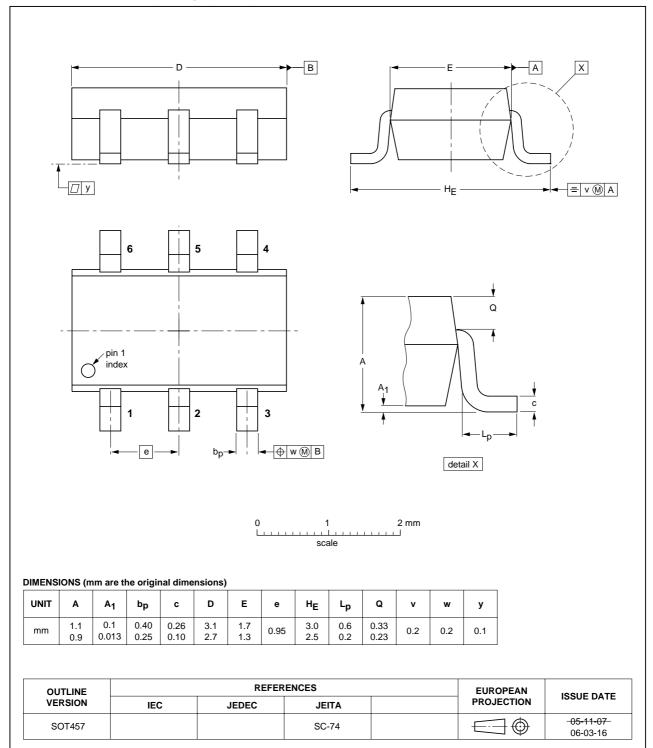


Fig 24. Package outline SOT457 (SC-74)

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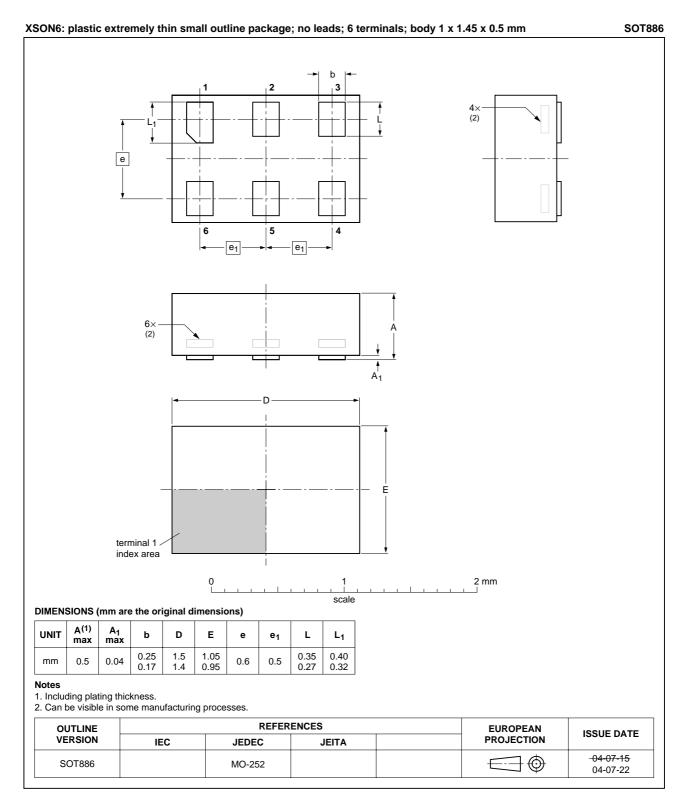


Fig 25. Package outline SOT886 (XSON6)

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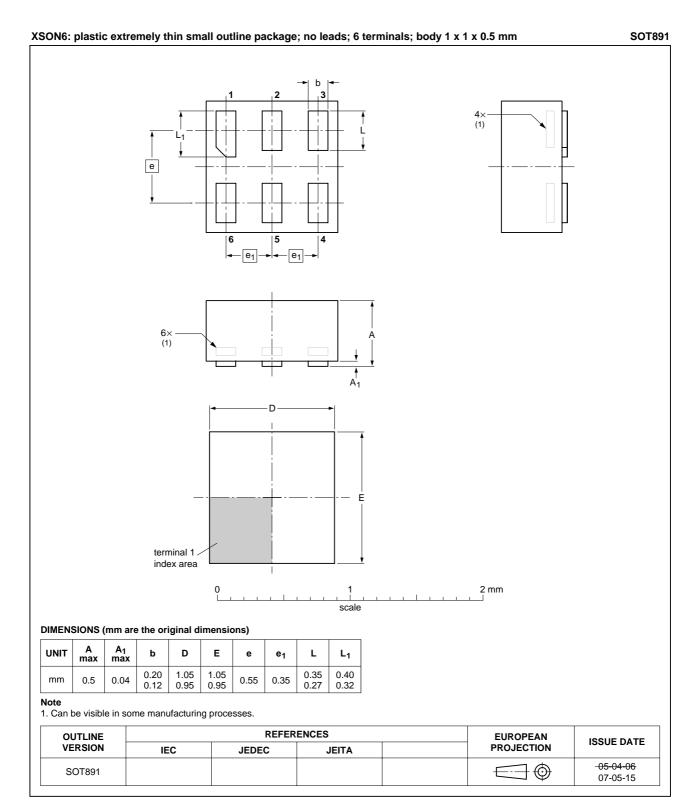


Fig 26. Package outline SOT891 (XSON6)

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## 13. Abbreviations

#### Table 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
TTL	Transistor-Transistor Logic
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
DUT	Device Under Test

# 14. Revision history

### Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC1G3157_2	20070918	Product data sheet	-	74LVC1G3157_1	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name when appropriate.</li> </ul>				
	<ul> <li>Added type number 74LVC1G3157GF (XSON6 package).</li> </ul>				
	Section 1 "General description":				
	Added: Schmitt trigger action at the enable input.				
	Section 2 "Features":				
	Added: Switch handling capability of 32 mA.				
	<ul><li>Section 8 "</li></ul>	Limiting values":			
	Added: Derating factors of the applicable packages.				
	<ul> <li>Section 10</li> </ul>	"Static characteristics":			
	Changed: Maximum values of ON resistance (peak) parameters and graphics.				
	Changed: Conditions for input leakage and supply current.				
	Changed: Conditions for OFF-state and ON-state leakage current.				
	<ul> <li>Section 11</li> </ul>	"Dynamic characteristics":			
	Changed: Typical values of the charge injection.				
74LVC1G3157_1	20050207	Product data sheet	-	-	

## 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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